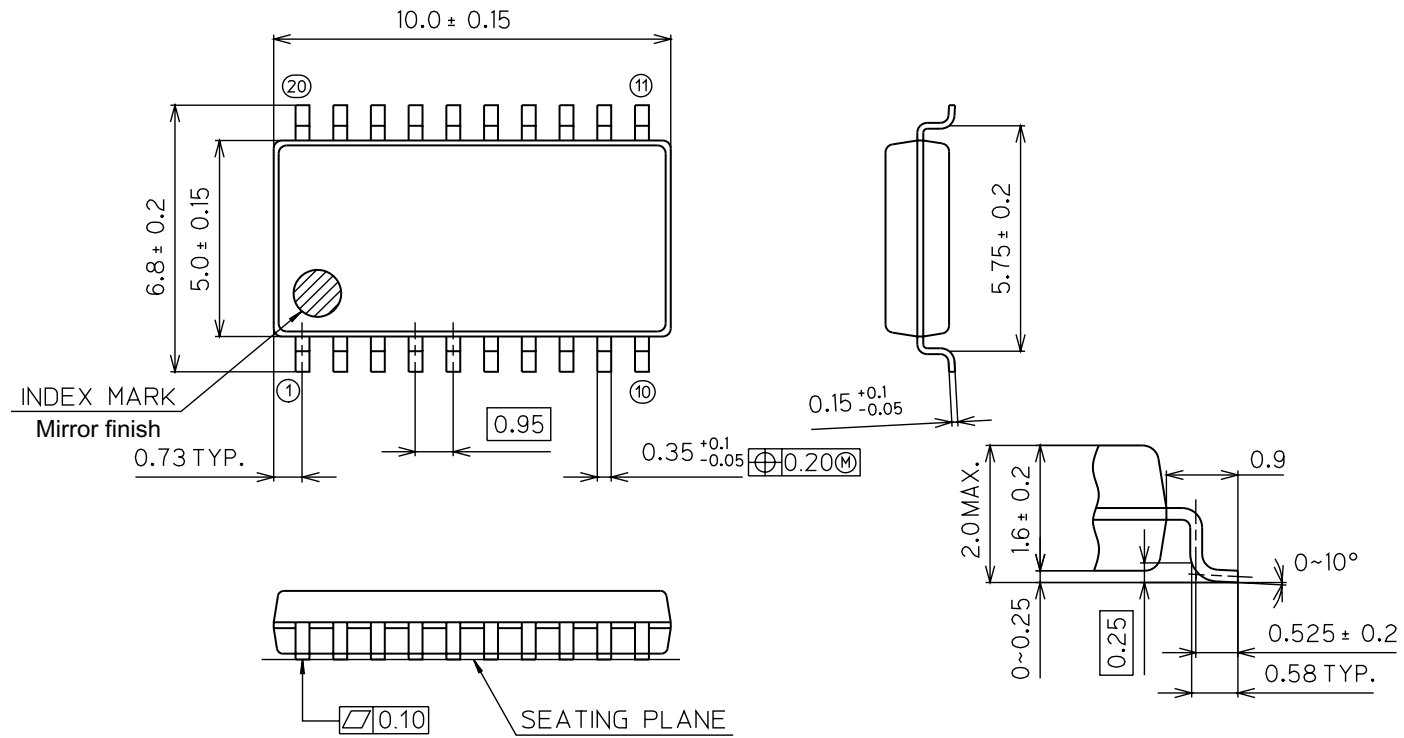


SSOP20-P-250-0.95-K



Package material	Epoxy resin
Lead frame material	42 alloy
Pin treatment	Solder plating ($\geq 5\mu\text{m}$)
Package weight (g)	0.18 TYP.
Rev. No./Last Revised	5/Oct. 13, 1998

Oki Electric Industry Co., Ltd.